



**SDI Review Form 1.6**

Journal Name:	<a href="#">Physical Science International Journal</a>
Manuscript Number:	Ms_PSIJ_29024
Title of the Manuscript:	Influence of Annealing Temperature on the Physical Properties of Polycrystalline Cu <sub>2</sub> SnSe <sub>3</sub> Thin Films Prepared by Thermal Vacuum Evaporation Technique
Type of the Article	Original Research Article

**General guideline for Peer Review process:**

This journal's peer review policy states that **NO** manuscript should be rejected only on the basis of '**lack of Novelty**', provided the manuscript is scientifically robust and technically sound.

To know the complete guideline for Peer Review process, reviewers are requested to visit this link:

(<http://www.sciencedomain.org/page.php?id=sdi-general-editorial-policy#Peer-Review-Guideline>)



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**PART 1: Review Comments**

	<b>Reviewer's comment</b>	<b>Author's comment</b> (if agreed with reviewer, correct the manuscript and highlight that part in the manuscript. It is mandatory that authors should write his/her feedback here)
<b><u>Compulsory</u></b> REVISION comments		
<b><u>Minor</u></b> REVISION comments		
<b><u>Optional/General</u></b> comments	The manuscript reports influence of annealing temperature on the physical properties of polycrystalline Cu <sub>2</sub> SnSe <sub>3</sub> thin films prepared by thermal vacuum evaporation technique. The manuscript is interesting and well organized. In my opinion, it can be accepted for publish.	

**Reviewer Details:**

Name:	<b>Lung-Chien Chen</b>
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